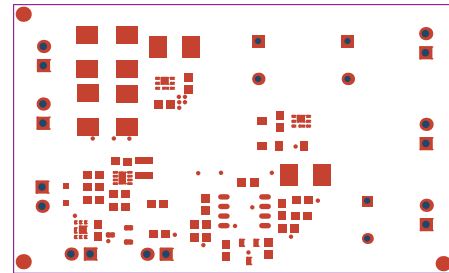
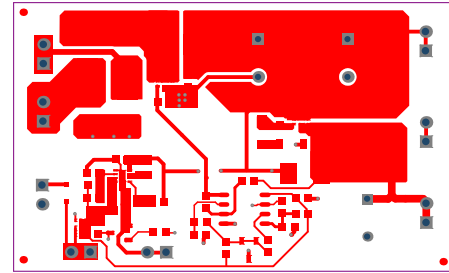


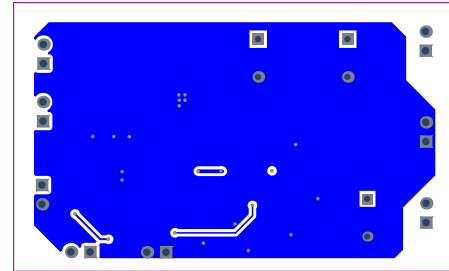
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00998_CT_EHS	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00998_CT_EHS		
PLOT NAME = Top Overlay	GENERATED : 3/28/2017 6:55:54 PM	TEXAS INSTRUMENTS	



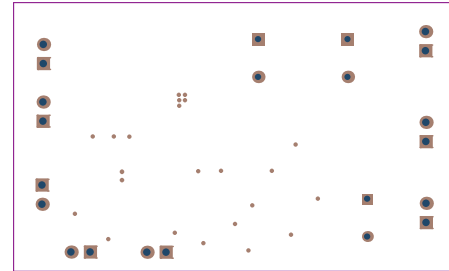
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00998_CT_EHS	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00998_CT_EHS		
PLOT NAME = Top Solder Mask	GENERATED : 3/28/2017 6:55:54 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00998_CT_EHS	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00998_CT_EHS		
PLOT NAME = Top Layer	GENERATED : 3/28/2017 6:55:54 PM	TEXAS INSTRUMENTS	



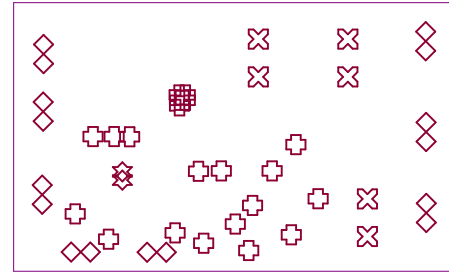
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00998_CT_EHS	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00998_CT_EHS		
PLOT NAME = Bottom Layer	GENERATED : 3/28/2017 6:55:54 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00998_CT_EHS	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00998_CT_EHS		
PLOT NAME = Bottom Solder Mask	GENERATED : 3/28/2017 6:55:54 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00998_CT_EHS	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00998_CT_EHS		
PLOT NAME = Bottom Overlay	GENERATED : 3/28/2017 6:55:55 PM	TEXAS INSTRUMENTS	

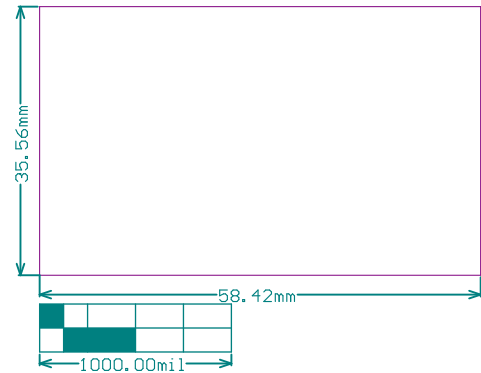


**DRILL TABLE**

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair
⊛	2	7.87mil (0.200mm)	PTH	Round	0.00mil (0.000mm)
⊕	21	10.00mil (0.254mm)	PTH	Round	0.00mil (0.000mm)
⊗	6	33.46mil (0.850mm)	PTH	Round	0.00mil (0.000mm)
◇	16	40.00mil (1.016mm)	PTH	Round	0.00mil (0.000mm)
	45 Total				

FOR 7.87MIL DRILL +0/-7.87MIL  
 FOR 10MIL DRILL +0/-10MIL  
 FOR PTH DRILL +/-3MIL

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00998_CT_EHS	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00998_CT_EHS		
PLOT NAME = Drill Drawing	GENERATED : 3/28/2017	6:55:55 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00998_CT_EHS	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M1 Board Outline	TID #: TIDA-00998_CT_EHS		
PLOT NAME = Board Dimensions	GENERATED : 3/28/2017 6:55:55 PM	TEXAS INSTRUMENTS	



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